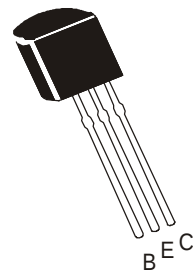




Continental Device India Limited

An IS/ISO 9002 and IECQ Certified Manufacturer

IS/ISO 9002
Lic# QSC/L-000019.3**NPN SILICON PLANAR EPITAXIAL TRANSISTOR****MPSH10****TO-92****Plastic Package****VHF/UHF Transistor****ABSOLUTE MAXIMUM RATINGS**($T_a=25^\circ\text{C}$ unless specified otherwise)

DESCRIPTION	SYMBOL	VALUE	UNITS
Collector Emitter Voltage	V_{CEO}	25	V
Collector Base Voltage	V_{CBO}	30	V
Emitter Base Voltage	V_{EBO}	3.0	V
Power Dissipation @ $T_a=25^\circ\text{C}$	P_D	350	mW
Derate Above 25°C		2.8	mW/ $^\circ\text{C}$
Power Dissipation @ $T_c=25^\circ\text{C}$	P_D	1.0	W
Derate Above 25°C		8.0	mW/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_j, T_{stg}	- 55 to +150	$^\circ\text{C}$

THERMAL RESISTANCE

Junction to Ambient in free air	$R_{th(j-a)}$	357	$^\circ\text{C/W}$
Junction to case	$R_{th(j-c)}$	125	$^\circ\text{C/W}$

ELECTRICAL CHARACTERISTICS ($T_a=25^\circ\text{C}$ unless specified otherwise)

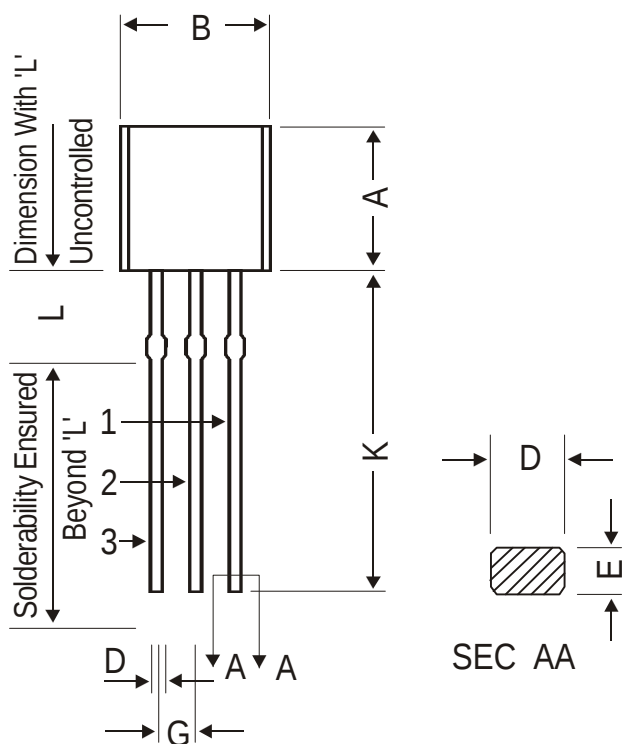
DESCRIPTION	SYMBOL	TEST CONDITION	MIN	MAX	UNITS
Collector Emitter Voltage	V_{CEO}	$I_C=1\text{mA}, I_B=0$	25		V
Collector Base Voltage	V_{CBO}	$I_C=100\mu\text{A}, I_E=0$	30		V
Emitter Base Voltage	V_{EBO}	$I_E=10\mu\text{A}, I_C=0$	3.0		V
Collector Cut off Current	I_{CBO}	$V_{CB}=25\text{V}, I_E=0$		100	nA
Emitter Cut off Current	I_{EBO}	$V_{EB}=2\text{V}, I_C=0$		100	nA
DC Current Gain	h_{FE}	$I_C=4\text{mA}, V_{CE}=10\text{V}$	60		
Collector Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=4\text{mA}, I_B=0.4\text{mA}$		0.50	V
Base Emitter On Voltage	$V_{BE(on)}$	$I_C=4\text{mA}, V_{CE}=10\text{V}$		0.95	V

DYNAMIC CHARACTERISTICS

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	MAX	UNITS
Transition Frequency	f_T	$I_C=4\text{mA}, V_{CE}=10\text{V}, f=100\text{MHz}$	650		MHz
Collector Base Capacitance	C_{cb}	$V_{CB}=10\text{V}, I_E=0, f=1\text{MHz}$		0.70	pF
Common Base feedback Capacitance	C_{rb}	$V_{CB}=10\text{V}, I_E=0, f=1\text{MHz}$	0.35	0.65	pF
Collector Base Time Constant	$rb' C_C$	$I_C=4\text{mA}, V_{CB}=10\text{V}, f=31.8\text{MHz}$		9.00	ps

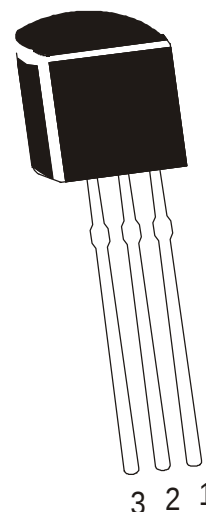
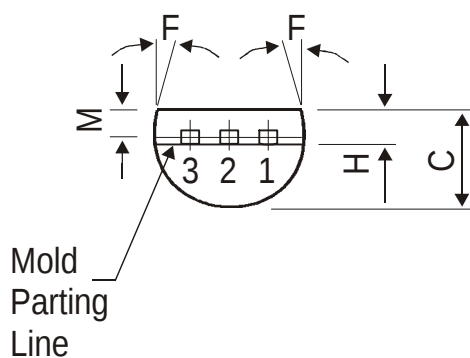
TO-92
Plastic Package

TO-92 Plastic Package



DIM	MIN.	MAX.
A	4.32	5.33
B	4.45	5.20
C	3.18	4.19
D	0.41	0.55
E	0.35	0.50
F	5 DEG	
G	1.14	1.40
H	1.20	1.40
K	12.70	—
L	1.982	2.082
M	1.03	1.20

All dimensions are in mm



PIN CONFIGURATION

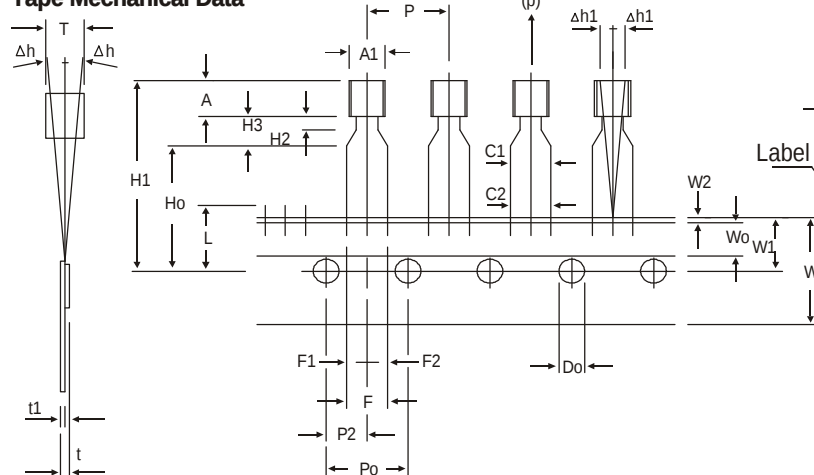
1. COLLECTOR
2. EMITTER
3. BASE

Packing Details

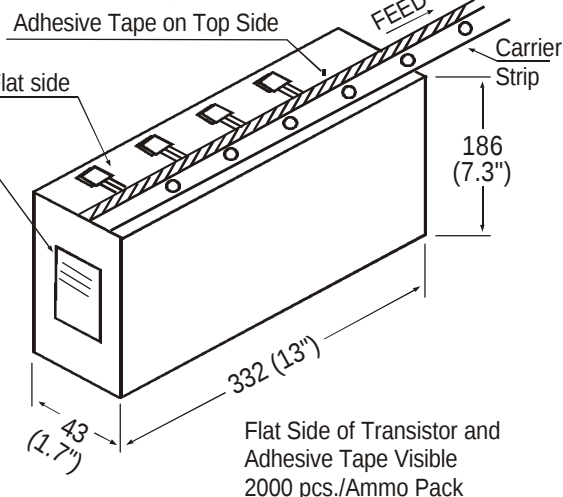
PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	12.5 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs

TO-92 Tape and Ammo Pack

Tape Mechanical Data



Ammo Pack Style



All dimensions are in mm

ITEM	SYMBOL	SPECIFICATION			
		MIN.	NOM.	MAX.	TOL .
BODY WIDTH	A1	4.0		4.8	
BODY HEIGHT	A	4.8		5.2	
BODY THICKNESS	T	3.9		4.2	
PITCH OF COMPONENT	P		12.7		± 1.0
*1 FEED HOLE PITCH	P0		12.7		± 0.3
*2 FEED HOLE CENTRE TO COMPONENT CENTRE	P2		6.35		± 0.4
DISTANCE BETWEEN OUTER LEADS	F		5.08		+ 0.6 - 0.2
*3 COMPONENT ALIGNMENT SIDE VIEW	Δh		0	1.0	
*4 COMPONENT ALIGNMENT FRONT VIEW	Δh1		0	1.3	
TAPE WIDTH	W		18		± 0.5
HOLD-DOWN TAPE WIDTH	W0		6		± 0.2
HOLE POSITION	W1		9		+ 0.7 - 0.5
HOLD-DOWN TAPE POSITION	W2		0.5		± 0.2
LEAD WIRE CLINCH HEIGHT	H0		16		± 0.5
COMPONENT HEIGHT	H1			23.25	
LENGTH OF SNIPPED LEADS	L			11.0	
FEED HOLE DIAMETER	Do		4		± 0.2
*5 TOTAL TAPE THICKNESS	t			1.2	
LEAD - TO - LEAD DISTANCE	F1, F2		2.54		+ 0.4 - 0.1
STAND OFF	H2	0.45		1.45	
CLINCH HEIGHT	H3			3.0	
LEAD PARALLELISM	C1 - C2			0.22	
PULL - OUT FORCE	(p)	6N			

NOTES

- Maximum alignment deviation between leads will not to be greater than 0.2mm.
- Maximum non-cumulative variation between tape feed holes shall not exceed 1 mm in 20 pitches.
- Holddown tape will not exceed beyond the edge(s) of carrier tape and there shall be no exposure of adhesive.
- There will be no more than three (3) consecutive missing components in a tape.
- A tape trailer, having at least three feed holes are provided after the last component in a tape.
- Splices should not interfere with the sprocket feed holes.

REMARKS

- *1 Cumulative pitch error 1.0 mm/20 pitch
- *2 To be measured at bottom of clinch
- *3 At top of body
- *4 At top of body
- *5 t1 0.3 – 0.6 mm

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Disclaimer

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